Amendments to the Claims:

This listing of claims will replace all prior versions, and listings, of claims in the application:

Claims 1 - 23. Cancelled.

24. (Currently Amended) A process for preparing halogen-containing silanes of the general formula (I):

$$R_a H_b SiX_c$$
 (I)

where

- is a substituted or unsubstituted $C_{1.10}$ alkyl or $C_{6.10}$ aryl radical of which one or more carbon atoms are optionally replaced by -CO-, -CO₂-, -O-, -So-, -SO-, -SO₂-, -NH- or -NR'-, where R' is a substituted or unsubstituted alkyl radical having from 1 to 20 carbon atoms,
- X is fluorine, chlorine or bromine,
- a is an integer of [[0,]] 1, 2 or 3,
- b is an integer of 0, 1, 2 or 3, and
- c is an integer of 1, 2, or 3 [[or 4]],

with the proviso that the sum of a + b + c = 4,

comprising reacting silicon, under the action of microwave energy, with elements or compounds selected from the group consisting of [[halogens;]] halogens and organohalogen compounds; halogens and hydrogen; halogens and hydrogen halides; organohalogen compounds and hydrogen halide; hydrogen halides; fluorosilanes and hydrogen; fluorosilanes and hydrogen halide; hydrogen-containing chlorosilanes and hydrogen; hydrogen-containing chlorosilanes and hydrogen; organohalosilanes and hydrogen halides; and hydrogen halides; and hydrogen halides; and hydrogen halides.

- (Currently Amended) The process of claim 24, wherein silicon is contacted with halogen, a halogen an organohalogen compound, or mixture thereof in gaseous form and exposed to microwave energy.
- (Previously Presented) The process of claim 24, wherein crystalline silicon is used.
- 27. (Previously Presented) The process of claim 24, wherein coarsely crystalline silicon is used.
- (Previously Presented) The process of claim 24, wherein amorphous silicon is used.
- (Previously Presented) The process of claim 28, wherein amorphous silicon is used in admixture with crystalline silicon.
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 36. (Previously Presented) The process of claim 24, further comprising employing a catalyst or promoter.
- (Previously Presented) The process of claim 24, further comprising employing a substance which absorbs microwave energy and transfers thermal energy to silicon.
 - 22. (Cancelled).
- 9 23. (Previously Presented) The process of claim 24, further comprising employing a metal or metal compound as a catalyst or promoter.
- (Previously Presented) The process of claim 23, wherein said promoter comprises Cu.

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- (Previously Presented) The process of claim 24, wherein nonpulsed microwave energy is used.
- 1 2 1 26. (Previously Presented) The process of claim 24, wherein said silicon has a mean particle size of $> 70 \mu m$.
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 27. (Previously Presented) The process of claim 24, wherein said organohalogen compound comprises an alkyl halide or aryl halide.
- 38. (Previously Presented) The process of claim 24, wherein said organohalogen compound comprises methyl chloride.
- (Previously Presented) The process of claim 24, wherein silicon is employed in the form of a silicon alloy.
- (Previously Presented) The process of claim 39, wherein said silicon alloy is ferrosilicon.

41. - 51. (Cancelled)

- (Previously Presented) The process of claim 24, wherein elemental silicon and one or more organohalogen compounds are contacted under microwave excitation with hydrogen, hydrogen halide, or hydrogen and hydrogen halide.
- (Previously Presented) The process of claim 24, wherein the hydrocarbon is methane or ethane.
 - 54. (Cancelled).

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(Previously Presented)

The process of claim 24, wherein the

silicon is free of catalysts.